

Docket No. 221158US9000CT



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[Signature]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yasutaka ITO, et al.

SERIAL NO: 10/088,098

GAU: 3742

FILED: May 30, 2002

EXAMINER: FUQUA, Shawntina T.

FOR: CERAMIC SUBSTRATE FOR SEMICONDUCTOR MANUFACTURE/INSPECTION APPARATUS, CERAMIC HEATER, ELECTROSTATIC CLAMPLESS HOLDER, AND SUBSTRATE FOR WAFER PROBER

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☒ Attached is a list of applicant's application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the application(s) is attached along with PTO 1449.
- ☒ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

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Customer Number

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Tel. (703) 413-3000
Fax. (703) 413-2220
(OSMMN 05/03)

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.

Joseph A. Scafetta Jr.

Masayasu Mori

Registration No. 47,301

Joseph A. Scafetta, Jr.
Registration No. 26, 803

Form PTO 1445
(Modified)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.

221158US90PCT

SERIAL NO.

10/088,098

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Yasutaka ITO, et al.

FILING DATE

May 30, 2002

GROUP

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U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,507,006	1/14/03	Hiramatsu, et al.			
	AB	6,465,763	10/15/02	Ito, et al.			
	AC	6,677,557	1/13/04	Ito et al			
	AD	6,710,307	3/23/04	Ito, et al.			
	AE	6,475,606	11/5/02	Niwa			
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	AG	US2003/0015521	1/23/03	Ito			
	AH						
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	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO					
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	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
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	AZ	

☐ Additional References sheet(s) attached

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



LIST OF RELATED CASES

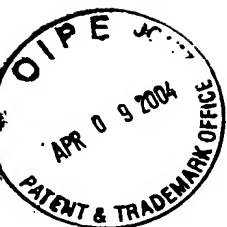
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*Present Application; listed for information

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